

XC1701LPDG8C Information


For Reference Only

Part Number [XC1701LPDG8C](#)
Manufacturer Xilinx Inc.
Category Integrated Circuits (ICs)
[Memory - Configuration Proms for FPGAs](#)
Description IC PROM SER CONFIG 1M 3.3V 8-DIP
Package 8-DIP (0.300", 7.62mm)
 For the pricing/inventory/lead time, please contact us
 Website: <https://www.heisener.com>
 E-mail: salesdept@heisener.com


[Request a Quote](#)
Certified Quality

Heisener's commitment to quality has shaped our processes for sourcing, testing, shipping, and every step in between. This foundation underlies each component we sell.


XC1701LPDG8C Specifications

Manufacturer Part Number	XC1701LPDG8C
Manufacturer	Xilinx Inc.
Category	Integrated Circuits (ICs) Memory - Configuration Proms for FPGAs
Package	8-DIP (0.300", 7.62mm)
Series	-
Programmable Type	OTP
Memory Size	1Mb
Voltage - Supply	3 V ~ 3.6 V
Operating Temperature	0°C ~ 70°C
Package / Case	8-DIP (0.300", 7.62mm)
Supplier Device Package	8-PDIP
Report errors?	

XC1701LPDG8C Guarantees

Quality Guarantees

We provide 90 days warranty. *

If the items you received were not in perfect quality, we would be responsible for your refund or replacement, but the items must be returned in their original condition.


Service Guarantees

We guarantee 100% customer satisfaction.

Our experienced sales team and tech support team back our services to satisfy all our customers.

XC1701LPDG8C Payment Methods



XC1701LPDG8C Shipping Methods



If you have any question about XC1701LPDG8C, please do not hesitate to contact us!

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